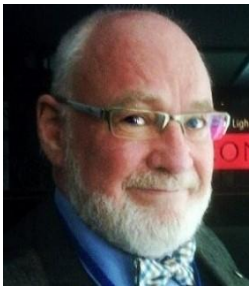
Welcome Letter



Greetings from Korea!

As a Member of the Congress Organizing Committee, it is my pleasure and honor on behalf of the Conference President and my fellow Committee Members to extend to all potential attendees a very warm welcome to the 2020 Conference on Laser Advanced Materials Processing, which will be held in the beautiful city of Osaka, Japan, on May 20-21, 2020.

Although the field of advanced materials processing with lasers might appear to be a somewhat specialized one, in fact this huge arena encompasses many different disciplines. Topics covered at the conference will include, but will not be limited to, basic laser physics, laser types and optics, beam delivery systems, industrial applications of laser energy including micro-patterning and nano processing, laser safety and my own particular area, the dramatically expanding application of lasers in medicine and surgery, encompassing surgical, aesthetic and phototherapeutic indications.

With such a wide scope, the meeting should hold a great deal of interest for a wide range of potential attendees from both the academic, medical and industrial fields. In addition, the conference will be a great opportunity for researchers and leaders in the field to network interface and interact with experts looking for collaborative potential, with new product developers and with solution providers.

So, don't miss this exciting event! Please put May 20th and 21st in your 2020 calendars, and plan to make your way to Japan, to the historic, industrial and university city of Osaka, to participate in the 2020 Conference on Laser Advanced Materials Processing. You will make new friends, cement old friendships, and expand your field of interest in lasers, the light of the New Millennium!

Sincerely,

R Glen Calderhead MSc PhD DrMedSci FRSM
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